

AMENDMENTS

In the Claims:

1-29. (Cancelled)

30. (Previously Presented) A method for manufacturing a coating package, comprising:

- providing a flat, flexible carrier; and
- applying at least one covering layer to the carrier, wherein the covering layer is cross-linked on the carrier,
- wherein the covering layer comprises perforations, and
- wherein the carrier comprises a layer configured to attach to and separate from the covering layer.

31. (Previously Presented) The method as claimed in claim 30, wherein the openings in the covering layer have a size ranging from 5 μm to 100 μm .

32-33. (Cancelled)

34. (Previously Presented) The method as claimed in claim 35, wherein the adhesive layer is applied to the covering layer before applying the covering layer to the substrate.

35. (Previously Presented) A method for applying a covering layer to a substrate, the method comprising:

- providing a coating package comprising:
 - a flat, flexible carrier;
 - a covering layer, wherein the covering layer is cross-linked on the carrier, and wherein the covering layer comprises openings,
 - wherein the carrier comprises a layer configured to attach to and separate from the covering layer;
- at least partly separating the carrier from the covering layer;

applying an adhesive layer in a non-cross-linked state between the covering layer and a substrate; and
applying the covering layer to the substrate;
wherein at least one of the covering layer and the adhesive layer is a paint layer.

36. (Previously Presented) A method for applying a covering layer to a substrate comprising:

providing a coating package comprising:
a flat, flexible carrier;
a covering layer, wherein the covering layer is cross-linked on the carrier, and wherein the covering layer comprises openings,
wherein the carrier comprises a layer configured to attach to and separate from the covering layer;
at least partly separating the carrier from the covering layer;
applying an adhesive layer in a non-cross-linked state between the covering layer and a substrate; and
applying the covering layer to the substrate;
wherein at least one of the covering layer and the carrier comprises a loose or woven fiber product.

37. (Previously Presented) The method as claimed in claim 36, wherein the fiber product comprises glass or synthetic fibers.

38. (Previously Presented) A method for applying a covering layer to a substrate comprising:

providing a coating package comprising:
a flat, flexible carrier;
a covering layer, wherein the covering layer is cross-linked on the carrier, and wherein the covering layer comprises openings,
wherein the carrier comprises a layer configured to attach to and separate from the covering layer;

at least partly separating the carrier from the covering layer;
applying an adhesive layer in a non-cross-linked state between the covering layer and a substrate; and
applying the covering layer to the substrate;
wherein the coating package further comprises spacers for holding the covering layer at a predetermined distance relative to the substrate.

39. (Previously Presented) The method as claimed in claim 38, wherein the spacers are positioned at one or more of the following: on a side of the covering layer which comes into contact with the adhesive layer, in the adhesive layer, and on the adhesive layer.

40. (Previously Presented) The method as claimed in claim 38, wherein the spacers are configured such that they are formed integrally with the covering layer.

41. (Previously Presented) The method as claimed in claim 35, wherein at least one of the covering layer and the adhesive layer comprises an elasticizing additive.

42. (Previously Presented) A method for applying a covering layer to a substrate comprising:

providing a coating package comprising:
a flat, flexible carrier;
a covering layer, wherein the covering layer is cross-linked on the carrier, and wherein the covering layer comprises openings,
wherein the carrier comprises a layer configured to attach to and separate from the covering layer;
at least partly separating the carrier from the covering layer;
applying an adhesive layer in a non-cross-linked state between the covering layer and a substrate; and
applying the covering layer to the substrate;
wherein the method is a method for applying a coating to a surface of a building.

43. (Previously Presented) The method as claimed in claim 42, wherein the surface comprises a window frame or a door.

44. (Previously Presented) The method as claimed in claim 35, wherein a distance A is defined which corresponds to the distance between the upper side of the substrate and the upper side of the covering layer, and wherein the distance A has a value ranging from 0.01 mm to 1 mm.

45. (Previously Presented) The method as claimed in claim 44, wherein the distance A has a value ranging from 0.01 to 0.1 mm.

46. (Previously Presented) A coating package comprising:
a flat, flexible carrier; and
a covering layer, wherein the covering layer is cross-linked on the carrier, and wherein the covering layer comprises perforations,
wherein the carrier comprises a layer configured to attach to and separate from the covering layer.

47. (Previously Presented) The coating package as claimed in claim 46, wherein the openings in the covering layer have a size ranging from 5 μm to 100 μm .

Claims 48-50. (Cancelled).